

Product Brief

.

Description

- This Customized module is based on White
 Colored surface-mount LED comes in
 standard package dimension. Package
 Size : 5.0x5.0x0.70mm
- The package design coupled with careful sele ction of component materials allow these pro ducts to perform with high reliability.





Features and Benefits

- High Intensity output and high luminance
- High Efficacy
- Compatible with 3rd party optics
- Lead free product
- RoHS compliant

Key Applications

- Street Lighting
- Area Lighting
- Residential Lighting
- Urban Lighting

SMJD-3625012F-XXN1

Table 1. Order Code

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Nominal CCT (K)	CRI	Lens Type	Order Code
6500	70	No lens	SMJD-3625012F-XXN100E40A057ALL
5700	70	No lens	SMJD-3625012F-XXN100E40B057ALL
5000	70	No lens	SMJD-3625012F-XXN100E56C057ALL
4000	70	No lens	SMJD-3625012F-XXN100E56E057ALL
3000	70	No lens	SMJD-3625012F-XXN100E40G057ALL
2200	70	No lens	SMJD-3625012F-XXN100D43K057ALL





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SMJD-3625012F-XXN1

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Performance Characteristics

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Table 2-1. Electro Optical Characteristics $T_c = 25^{\circ}C$, $I_F = 0.7A$

			Value			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Mark
		4090	4400	-		A, B, G rank
Luminous Flux	$\Phi_V^{[2]}$	4240	4560	-	lm	C,E rank
		3190	3430	-		K rank
		-	175	-		A, B, G rank
Luminous Efficiency	LPW	-	181	-	Lm/W	C,E rank
		-	136	-		K rank
		6000	6500	7000		A05
	ССТ	5300	5700	6000		B05
Correlated Color		4700	5000	5300	K	C05
Temperature [3]		3700	4000	4200	- К	E05
		2900	3000	3200		G05
		2100	2200	2300		K05
CRI	Ra	70	-	-	-	
Color Consistency	-	-	-	5	SDCM	
Input Voltage ^[4]	V _{in}	34	36	39	Vdc	
Input Current	I _F	-	0.7	-	А	-
Power	Р		25.2		W	
Viewing Angle	20 _{1/2}		120		deg.	

Table 2-2. Electro Optical Characteristics T_c = 85°C, I_F = 0.7A

Devementer	Cumbel		Value		Unit	Mosk		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Mark		
		3680	3960	-	_	A, B, G rank		
Luminous Flux	$\Phi_V^{[2]}$	3810	4100		Im	C,E rank		
		2870	3080	-		K rank		
Input Voltage	V _{in}	32	32 34		34 36		Vdc	
Power	Р		23.8		W			

Notes :

- 1. The above data were tested at Tc= 25 °C.
- 2. ΦV is the total luminous flux output measured with an integrated sphere.
- 3. Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.
- 4. To use the module properly, recommend to drive the module by a Constant Current Source (CCS). But the Maximum output voltage of the CCS should be limited by referring this sheet

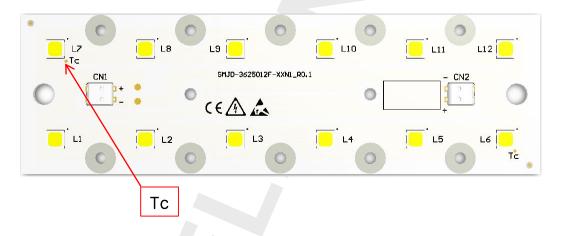
Absolute Maximum Ratings

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Table3. Absolute Maximum Ratings, T_c= 25°C

Parameter	Symbol	Unit	Value	Remark
Power Consumption	Р	W	37.8	P_ _{Typ.} = 25.2W
Driving Current ⁽²⁾	I _F	А	1.05	I _{F_Typ.} = 0.7A
Operating Temperature ⁽³⁾	T _c	٥C	- 40 ~ 100	Reference point
Storage Temperature	T _{stg}	٥C	- 40 ~ 100	With no power
ESD Sensitivity	-		±4,000V HBM	Class 2 JESD22-A114-E

ILLUSTRATION 1: How to predict components temperature ⁽⁴⁾

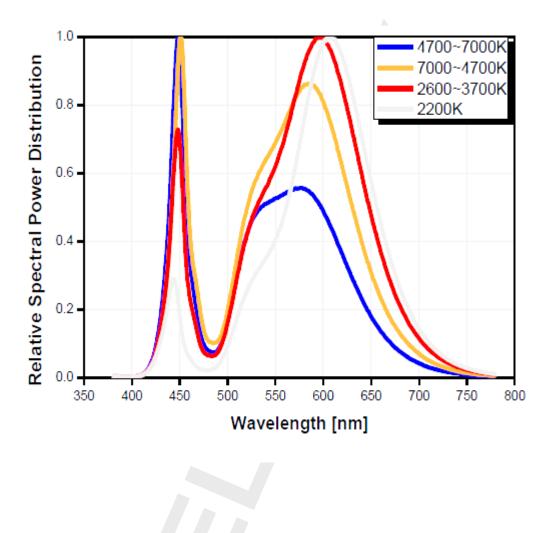


Notes :

- (1) All guarantee are based on the Absolute Maximum Ratings listed.
- (2) Please use a Constant Current Source (CCS) to drive the module, the typical V_F of module is around 36VDC and V_{F_MAX} is around 39VDC, respectively.
- (3) Operating temperature was tested at the assigned Tc point on the PCB.
- (4) To ensure the module works properly, DO NOT let the Tc upper than 100 °C;



Characteristic Graph







Relative Spectral Distribution

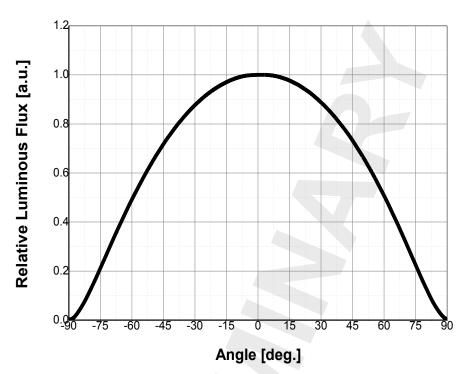
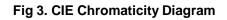
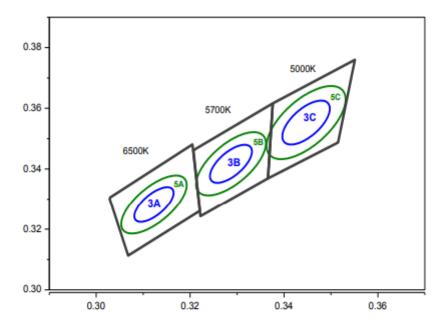


Fig 2. Typical Spatial Distribution



Color Bin Structure





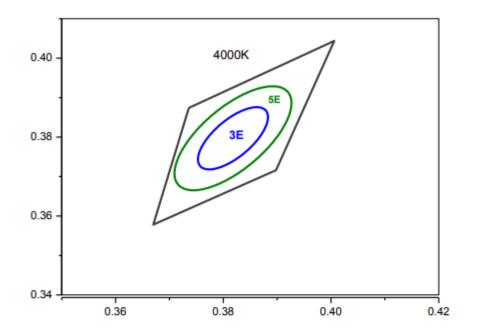
6500	K 3Step	5700	C 3Step	5000K 3Step				
	3A		3B		3C			
Center point	0.3123 : 0.3282	Center point	0.3287 : 0.3417	Center point	0.3447 : 0.3553			
Major Axis a	0.0066	Major Axis a	0.0071	Major Axis a	0.0081			
Minor Axis b	0.0027	Minor Axis b	0.003	Minor Axis b	0.0035			
Ellipse Rotation Angle	58	Ellipse Rotation Angle	59	Ellipse Rotation Angle	60			

6500	K 5Step	5700	K 5Step	5000K 5Step				
	5A		5B	5C				
Center point	0.3123 : 0.3282	Center point	0.3287 : 0.3417	Center point	0.3447 : 0.3553			
Major Axis a	0.0110	Major Axis a	0.0118	Major Axis a	0.0135			
Minor Axis b	0.0045	Minor Axis b	0.0050	Minor Axis b	0.0058			
Ellipse Rotation Angle	58	Ellipse Rotation Angle	59	Ellipse Rotation Angle	60			



Color Bin Structure





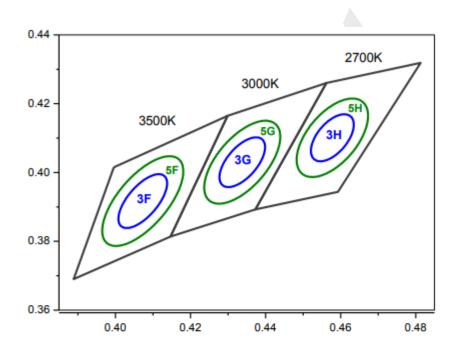
4000K 3Step									
3E									
Center point	0.3818 : 0.3797								
Major Axis a	0.00940								
Minor Axis b	0.00400								
Ellipse Rotation Angle	53								

4000K 5Step										
5E										
Center point	0.3818 : 0.3797									
Major Axis a	0.0157									
Minor Axis b	0.0067									
Ellipse Rotation Angle	53									



Color Bin Structure

Fig 5. CIE Chromaticity Diagram



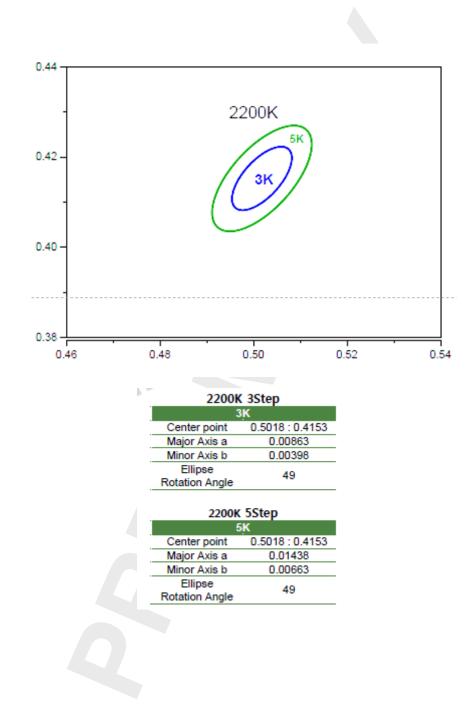
3500	K 3Step	3000	C 3Step	2700K 3Step			
1	3F		3 G	3H			
Center point	0.4073 : 0.3917	Center point	0.4338 : 0.4030	Center point	0.4578 : 0.4101		
Major Axis a	0.0093	Major Axis a	0.0085	Major Axis a	0.0079		
Minor Axis b	0.0041	Minor Axis b	0.0041	Minor Axis b	0.0041		
Ellipse Rotation Angle	53	Ellipse Rotation Angle	53	Ellipse Rotation Angle	54		

3500	K 5Step	3000	K 5Step	2700K 5Step			
	5F		5G	5H			
Center point	0.4073 : 0.3917	Center point	0.4338 : 0.4030	Center point	0.4578 : 0.4101		
Major Axis a	0.0155	Major Axis a	0.0142	Major Axis a	0.0132		
Minor Axis b	0.0068	Minor Axis b	0.0068	Minor Axis b	0.0068		
Ellipse Rotation Angle	53	Ellipse Rotation Angle	53	Ellipse Rotation Angle	54		



Color Bin Structure

Fig 6. CIE Chromaticity Diagram

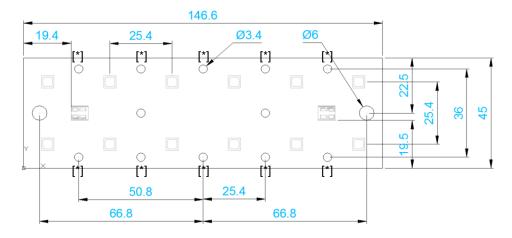




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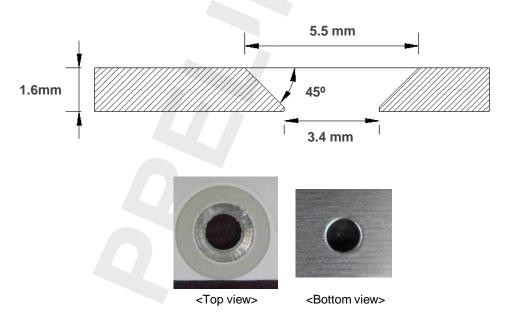
Mechanical Dimensions

Fig 7. Mechanical Diagram



- (1) All dimensions are in mm
- (2) Not to Scale
- (3) Module thickness 1.6 \pm 0.1 mm
- (4) [*] Marked Φ 3.4 (10 holes /PCB) holes are working to countersunk

[*] Countersunk Hole



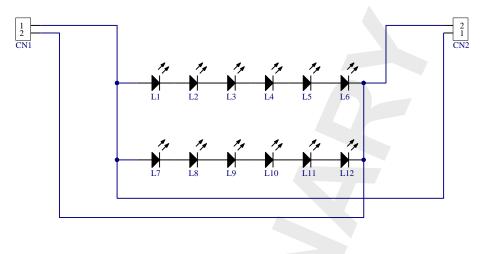
- (1) Working used $\Phi 6$ bit for reference
- (2) Burr is not allowed
- (3) Tolerance is ± 0.1 mm



Circuit Drawing

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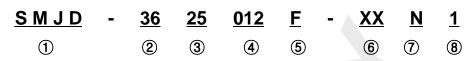
Fig 8. Schematic Diagram



Product Nomenclature

Product Name Rule:

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①: SMJD – Seoul Outdoor Module

 $(2 \sim 8)$: Refer to below table

	Volt	oltage			Ρον	ver			LED Qty.					LED Customer Type (Free)					Lens			
	(2			(D				(Ð				5		6		1		8	
	3		6		2		5		0		1		2		F		XX		Ν		1	
0	0	0	0	0	0	0	0	0	0	0	0	0	0	F	5050	xx	Reference	N	Normal	1	Version	
1	10V	1	1V	1	10W	1	1W	1	100EA	1	10EA	1	1EA					D	Dimming			
2	20V	2	2V	2	20W	2	2W	2	200EA	2	20EA	2	2EA									
3	30V	3	3V	3	30W	3	3W	3	300EA	3	30EA	3	3EA									
9	90V	9	9V	9	90W	9	9W	9	900EA	9	90EA	9	9EA									
А	100V			А	100W			А	1000EA					7								
в	110V			в	110W																	
z	350V			z	350W																	

Comments Rule:

(<u>00</u><u>WN</u><u>70</u>) A B C

Lens Type		сст		CRI	
	A		В		C
00		WN		70	
00	No lens		6500K	70	CRI70
		WO	5700K		
			5000K		
		WN	4000K		
		ww	3000K		
			2200k		

Product Nomenclature

Characteristics Rule:

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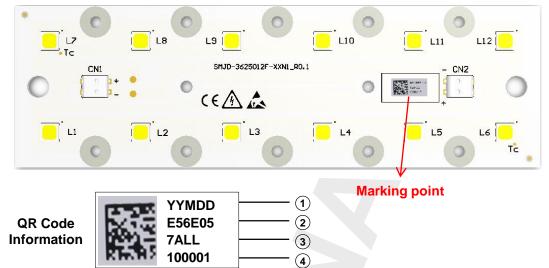
		_			0 <u>5</u> 7 C C		-	7	
Lens	s type	Flux bin		CCT bin		CRI bin		VF Bin ⁽¹⁾	
	A	В		С		D		E	
C	00	E56		E05		7		ALL	
		E56	4560 lm	A05	6500K 5-step				
		E40	4400 lm	B05	5700K 5-step				
		D43	3430 lm	C05	5000K 5-step				DC
00	00 No lens			E05	4000K 5-step	7	CRI70	ALL	34~39V
				G05	3000K 5-step				
				K05	2200K 5-step				

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Marking Information

Fig 9. Marking Point

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	QR Code Information							
Items	Factory	SAP Code	SMT Date	Rank Information	Line No.	Lot No.	Product	Notes
Digits	1 Digit	7 Digit	5 Digit	10 Digit	1 Digit	1 Digit	5 Digit	In Total
Information	*	*****	YYMDD	E56E05 7ALL	1~9, A~Z	1~9, A~Z	00001	30 Digits

Plain Code Information

No.	ltem	Information		Digits	Remark
1	Date		YYMDD	5Digit	SMT date
			E56		E56=4560lm
	Flux ⁽¹⁾	E40		3Digit	E40=4400lm
2			D43]	D43=3430lm
	ССТ	X05	5-step	3Digit	X=A,B,C,E,G
	CRI	7		1Dight	CRI=70
3	VF	ALL		3Digit	
	Lot No.	1		1 Digit	0~9,A~Z
(4)	Sequence No.	Sequence No. 00001		5 Digit	00001 ~ 99999



Part List

Table 4. Part List Table

No	Part	Specification	Q'ty
1	LED	STWOL8PA	12
2	MCPCB PCB	Metal (Al), 146.6 x 45 x 1.6mm	1
3	CN 1, CN 2	Wago2059-302/998-403	2

Label Information

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Model No.	SMJD-3625012F-XXN1 ⁽¹⁾
Rank	E56E057ALL ⁽²⁾
Туре	5-step ⁽³⁾
Quantity	
Lot No.	
SEOUL	SEOUL SEMICONDUCTOR CO.,LTD.

Notes

 (1) The model number designation is explained as follow SMJD : Seoul Semiconductor internal code
 25 : Power
 F : LED type

N: Normal

- (2) It represents the LED module rank.
 E54 : Luminous Flux Bin (E56 or E40)
 05 : Mixing CCT Bin
 ALL : LED Vf
- (3) It represents the Mac Adam 5-step.(4) It is attached to the top of a sealing pack & the bottom right corner of the box

36 : Input Voltage 012 : LED Quantity XX : Customer Initial 1: Version

 ${\sf E}:{\sf CCT}$ Bin (A or B or C or E or G) 7 : CRI Bin

	TOTAL Quantity
SEOU	SEOUL SEMICONDUCTOR CO.,LTD.

Notes

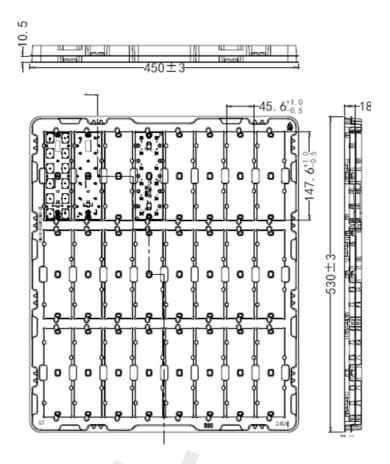
(1) It is attached to the bottom right corner of the box.



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Packaging Specification

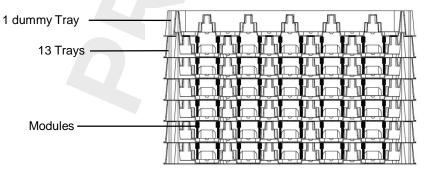
1. Tray information



Notes:

- (1) Quantity : 24 pcs/Tray
- (2) All dimensions are in millimeters (tolerance : ± 0.3)
- (3) Scale none

2. Tray stack and taping



Notes:

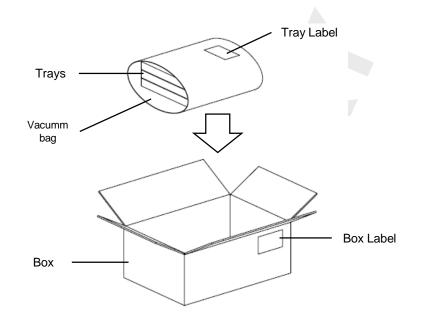
(1) 13 Trays and additional 1 dummy tray up of box



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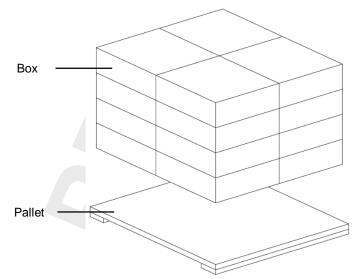
Packaging Specification

3. Box information & packing



Notes:

- (1) Quantity: 13 Trays (13*24=312pcs) / Box
- (2) Box size : 545*465*165 mm
- 4. Pallet information & packing



Notes:

- (1) Vessel Quantity: 1 Pallet = 28 Boxes = 364 Trays = 8736 Modules
- (2) Air Quantity: 1 Pallet = 24 Boxes = 312 Trays = 7488 Modules
- (3) Pallet size: 1100*1100 mm

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Precaution for Use

- (1) Check the appearance of module before wiring/ assembly, DO NOT use the LED cracked or PCB damaged module.
- (2) The module was designed to be driven with DC source, recognize the polarities of the module was necessity.
- (3) It was SELV module, DO NOT connect the LED directly to main power during wiring.
- (4) DO NOT let the LED packages contacted with any hard matters.
- (5) There was no current regulator built in module, unevenly load between different parallel modules may occur due to the modules V_F variance.
- (6) Please do not use together with the materials containing Sulfur.
- (7) Please do not make any modification on module.

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Precaution for Use

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- (8) LEDs are sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS).
 Below is a list of suggestions that Seoul Semiconductor purposes to minimize these effects.
- a. ESD (Electro Static Discharge)

Electrostatic discharge (ESD) is the defined as the release of static electricity when two objects come into contact. While most ESD events are considered harmless, it can be an expensive problem in many industrial environments during production and storage. The damage from ESD to an LEDs may cause the product to demonstrate unusual characteristics such as:

- Increase in reverse leakage current lowered turn-on voltage
- Abnormal emissions from the LED at low current

The following recommendations are suggested to help minimize the potential for an ESD event: One or more recommended work area suggestions:

- Ionizing fan setup
- ESD table/shelf mat made of conductive materials
- ESD safe storage containers
- One or more personnel suggestion options:
 - Antistatic wrist-strap
 - Antistatic material shoes
 - Antistatic clothes

Environmental controls

- Humidity control (ESD gets worse in a dry environment)
- b. EOS (Electrical Over Stress)

Electrical Over-Stress (EOS) is defined as damage that may occur when an electronic device is subjected to a current or voltage that is beyond the maximum specification limits of the device. The effects from an EOS event can be noticed through product performance like:

Changes to the performance of the LED package (If the damage is around the bond pad area and since the package is completely encapsulated the package may turn on but flicker show severe performance degradation.)

Changes to the light output of the luminaire from component failure

Components on the board not operating at determined drive power

Failure of performance from entire fixture due to changes in circuit voltage and current across total circuit causing trickle down failures

It is impossible to predict the failure mode of every LED exposed to electrical overstress as the failure modes have been investigated to vary, but there are some common signs that will indicate an EOS event has occurred.

- Damaged may be noticed to the bond wires (appearing similar to a blown fuse).
- Damage to the bond pads located on the emission surface of the LED package

(shadowing can be noticed around the bond pads while viewing through a microscope).

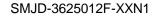
- Anomalies noticed in the encapsulation and phosphor around the bond wires.
- This damage usually appears due to the thermal stress produced during the EOS event.
- c. To help minimize the damage from an EOS event Seoul Semiconductor recommends utilizing
 - qualified LED driver with no big over shoot out put
 - Isolated driver that to prevent harmful peaks passed to module.
 - A current limiting device

Storage before use

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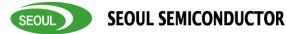
- (1) Do not impact or place pressure on this product because even a small amount of pressure can damage the product. The product should also not be placed in high temperatures, high humidity or direct sunlight since the device is sensitive to these conditions.
- (2) When storing devices for a long period of time before usage, please following these guidelines:
 * The devices should be stored in the anti-static bag that it was shipped in from Seoul-Semiconductor with opening.
 - * If the anti-static bag has been opened, re-seal preventing air and moisture from being present in the bag.

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Guidelines for properly working with Module

- (1) Discharge the lighting system a minimum of 2-3 times prior to working with the module.
- (2) Use only properly rated test equipment and tools for the rated voltage and current of the product being tested.
- (3) It is strongly suggested to wear rubber insulated gloves and rubber bottom shoes.
- (4) Do not wear any conductive items (such as jewelry) which could accidentally contact electric circuits.
- (5) Perform several tests with power off and the lighting system unplugged.
- (6) Faults, lightning, or switching transients can cause voltage surges in excess of the normal ratings.
- (7) Internal component failure can cause excessive voltages.
- (8) Stored or residual electricity in long wire could be hazardous.
- (9) Make sure proper discharge prior to starting work.



Company Information

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Company Information

Seoul Semiconductor (SeoulSemicon.com) manufacturers and packages a wide selection of light emitting diodes (LEDs) for the automotive, general illumination/lighting, appliance, signage and back lighting markets. The company is the world's fifth largest LED supplier, holding more than 10,000 patents globally, while offering a wide range of LED technology and production capacity in areas such as "nPola", deep UV LEDs, "Acrich", the world's first commercially produced AC LED, and "Acrich MJT - Multi-Junction Technology" a proprietary family of high-voltage LEDs. The company's broad product portfolio includes a wide array of package and device choices such as Acrich, high-brightness LEDs, mid-power LEDs, side-view LEDs, through-hole type LED lamps, custom displays, and sensors. The company is vertically integrated from epitaxial growth and chip manufacture in it's fully owned subsidiary, Seoul Viosys, through packaged LEDs and LED modules in three Seoul Semiconductor manufacturing facilities. Seoul Viosys also manufactures a wide range of unique deep-UV wavelength devices.

Legal Disclaimer

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Rev 0.2, Aug 26, 2019



Revision History

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Revision	Date	Page	Remarks
Rev0.1	2019-08-02	All	Preliminary data sheet for SMJD-3625012F-XXN1
Rev0.2	2019-08-26	All	Added CCT 2200K information